Process / Product Change Notification

N° 1211-DISTI42-C4048408-Private

Dear Customer,

Please find attached our INFINEON Technologies PCN:

Introduction of an Additional Wafer Production Location GTBF Dongguan, China for TO220 and D2PAK 3L MOSFET Products.

Important information for your attention:

- 🟥 Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before **19-April-2019**.
- 🟥 Infineon aligns with the widely-recognized JEDEC STANDARD **"JESD46"**, which stipulates:
  "Lack of acknowledgment of the PCN within 30 days constitutes acceptance of the change."

Your prompt reply will help Infineon Technologies to assure a smooth and well executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG
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Chairman of the Supervisory Board: Dr. Eckart Sünner
Management Board: Dr. Reinhard Ploss (CEO), Dominik Asam, Dr. Helmut Gassel, Jochen Hanebeck
Registered Office: Neubiberg Commercial Register
Amtsgericht München HRB 126492

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- **Products affected:** Please refer to attached affected products list 1211-DISTI42-C4048408-AffectedParts.xlsx

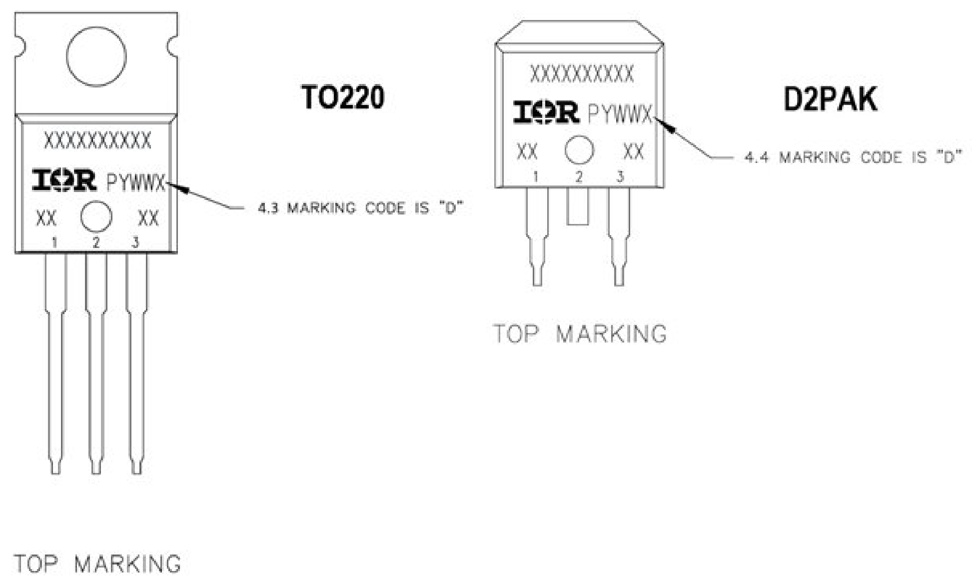
- **Detailed Change Information:**

Subject:	Introduction of an Additional Wafer Production Location GTBF Dongguan, China for TO220 and D2PAK 3L MOSFET Products.
Reason:	Expansion of wafer production to assure continuity of supply and enable flexible manufacturing.

Description:

Old	New
TO220	
- **Assembly site** SP Semiconductors, Korea	SP Semiconductors, Korea and GTBF Dongguan, China
- **Wire type** Aluminum	NI-Doped Aluminum
- **Mold compound** SG-8200DL	KE-G300BH
D2PAK	
- **Assembly site** SP Semiconductors, Korea	SP Semiconductors, Korea and GTBF Dongguan, China
- **Wire type** Aluminum	NI-DOPED AL WIRE
- **Mold compound** SG-8300HDT	CEL9220HF13MGP

Factory code marking



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Product Identification:	Traceability assured via date code. Factory code marking is "D“(Section 4.3 for TO220 and Section 4.4 for D2Pak) at GTBF.
Impact of Change:	No impact on electrical performance. Quality and reliability verified by qualification. There is no change in form, fit and function.
Attachments:	1211-DISTI42-C4048408-AffectedParts.xlsx

Time Schedule:

Final qualification report:	Available on request
First samples available:	Available on request
Intended start of delivery:	18-June-2019 or earlier upon customer approval

If you have any questions, please do not hesitate to contact your local Sales office.